

Features

- Saturated Output Power: +41 dBm
- Linear Gain: 24 dB
- Power Added Efficiency: 30% at P_{SAT}
- 50 Ω Input / Output Match
- Ceramic Flange Mount Package
- RoHS* Compliant and 260°C Re-flow Compatible

Description

The MAAP-010168 is a two stage MMIC power amplifier designed for broadband high power applications. It can be used as either a driver or an output stage amplifier. This device is fully matched input and output to 50 Ω which eliminates any sensitive external RF tuning components.

The device is packaged in a lead free 10-lead flanged package for high volume manufacturing.

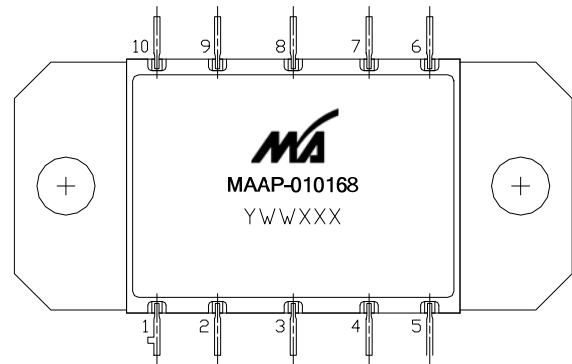
The MAAP-010168 is fabricated using a high reliability pHEMT process, to realize good power added efficiency and gain. The pHEMT process features full passivation for high performance and reliability.

Ordering Information¹

| Part Number | Package |
|--------------------|---------|
| MAAP-010168-000000 | Bulk |

1. Reference Application Note M567 for package handling and mounting procedure.

Functional Schematic



Pin Configuration²

| Pin No. | Function |
|---------|-----------|
| 1 | V_{GG2} |
| 2 | V_{GG1} |
| 3 | RF Input |
| 4 | V_{GG1} |
| 5 | V_{GG2} |
| 6 | V_{DD1} |
| 7 | V_{DD2} |
| 8 | RF Output |
| 9 | V_{DD2} |
| 10 | V_{DD1} |

2. Flange is DC and RF ground.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

* Restrictions on Hazardous Substances,
European Union Directive 2002/95/EC.

Electrical Specifications:

Freq. = 0.5 - 3.0 GHz, $V_{DD} = 10$ V, $I_{DQ} = 3.5$ A, $T_A = 25$ °C, $Z_0 = 50$ Ω

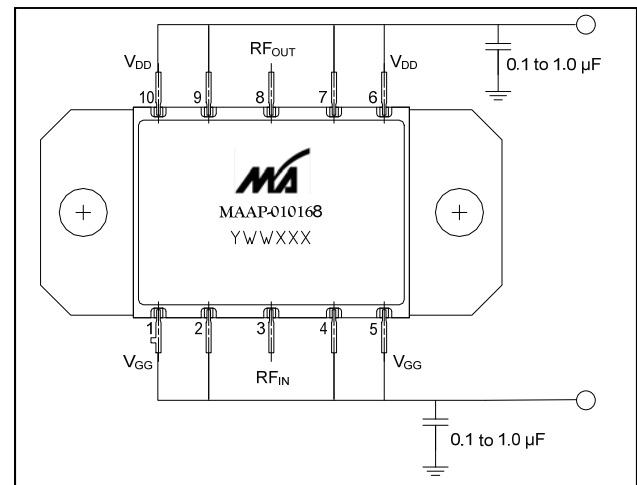
| Parameter | Test Conditions | Units | Min. | Typ. | Max. |
|--------------------|-----------------------|-------|--------|------------|--------|
| Gain | Small signal | dB | 19 | 24 | — |
| Input Return Loss | — | dB | — | 10 | — |
| Output Return Loss | — | dB | — | 10 | — |
| P1dB | — | dBm | — | 39 | — |
| P_{SAT} | — | dBm | 38 | 41 | — |
| Current | I_{DQ} P_{SAT} | A | — — | 3.5 5.5 | — — |
| PAE | P_{SAT} | % | — | 30 | — |
| Gate Bias | — | V | — | -0.7 | — |
| Duty Cycle | — | % | — | — | 100 |

Absolute Maximum Ratings^{3,4,5}

| Parameter | Absolute Maximum |
|----------------------------------|------------------|
| Input Power | +24 dBm |
| Operating Supply Voltage | +11 Volts |
| Operating Gate Voltage | -2 Volts |
| Operating Temperature | -40°C to +85°C |
| Channel Temperature ⁶ | +150 °C |
| Storage Temperature | -40°C to +150°C |

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM Technology Solutions does not recommend sustained operation near these survivability limits.
- Operating at nominal conditions with $T_J \leq +150$ °C will ensure MTTF > 1×10^6 hours.
- Junction Temperature (T_J) = $T_C + \Theta_{JC} * ((V * I) - (P_{OUT} - P_{IN}))$
Typical thermal resistance (Θ_{JC}) = 2.0°C/W
 - For $T_C = 25$ °C @ 1.5 GHz
 $T_J = +80$ °C @ +10 V, 4000 mA, $P_{OUT} = 41$ dBm, $P_{IN} = 21$ dBm
 - For $T_C = 85$ °C @ 1.5 GHz
 $T_J = +138$ °C @ +10 V, 3900 mA, $P_{OUT} = 41$ dBm, $P_{IN} = 21$ dBm

Recommended Bias Configuration



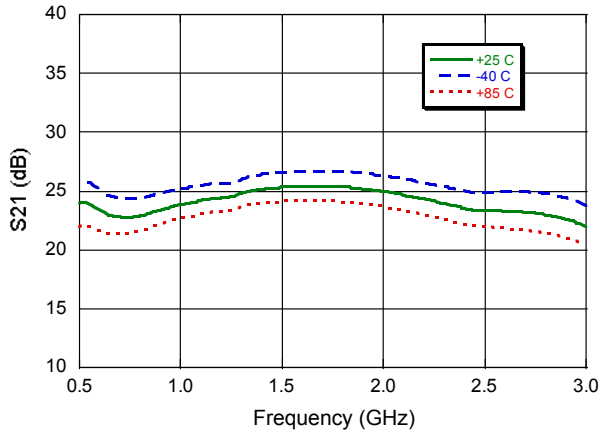
Operating the MAAP-010168

The MAAP-010168 is static sensitive. Please handle with care. To operate the device, follow these steps. Ramp down or shutdown in reverse order (gate bias on first and off last). All V_{GG} pins should have the same voltage applied at all times.

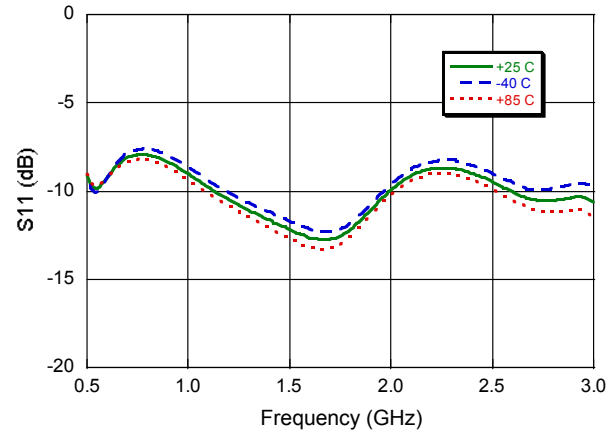
- Apply V_{GG} (-1.5 V).
- Apply V_{DD} (10.0 V Typical).
- Set I_{DQ} by adjusting V_{GG} .
- Apply RF_{IN} .

Typical Performance Curves

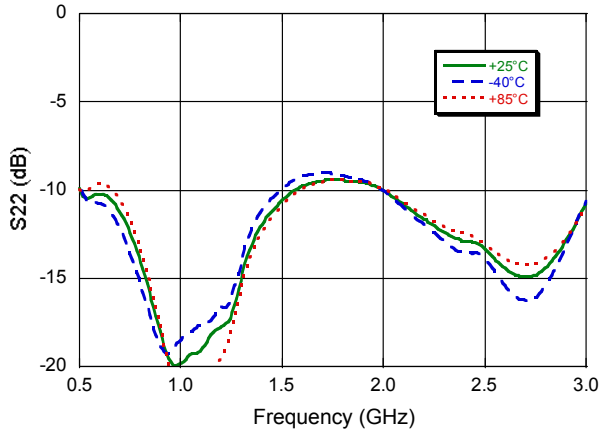
Gain



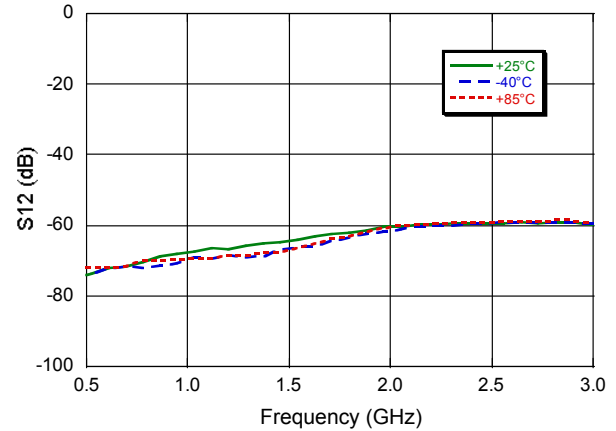
Input Return Loss



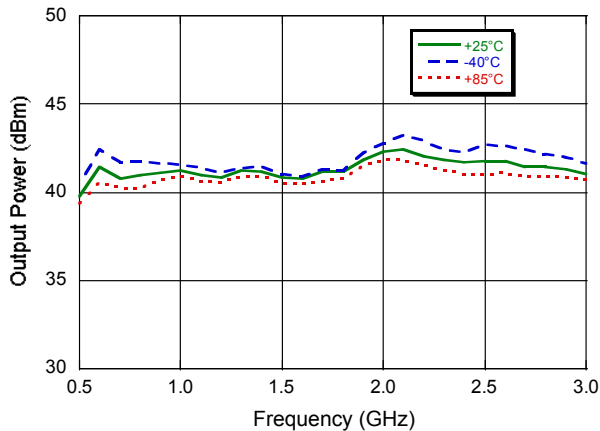
Output Return Loss



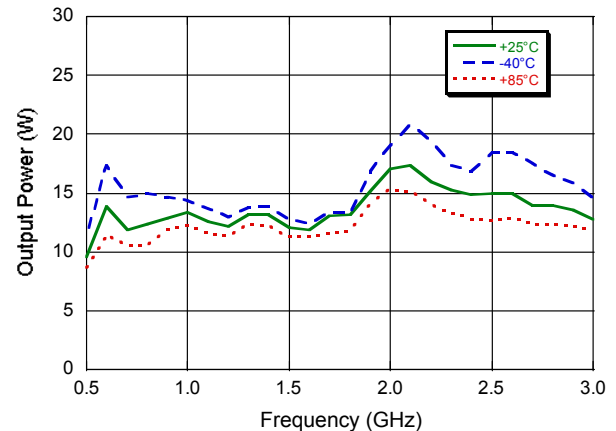
Reverse Isolation



Output Power (dBm)

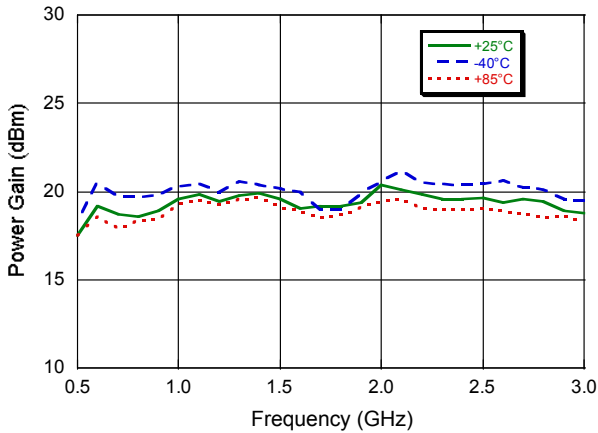


Output Power (W)

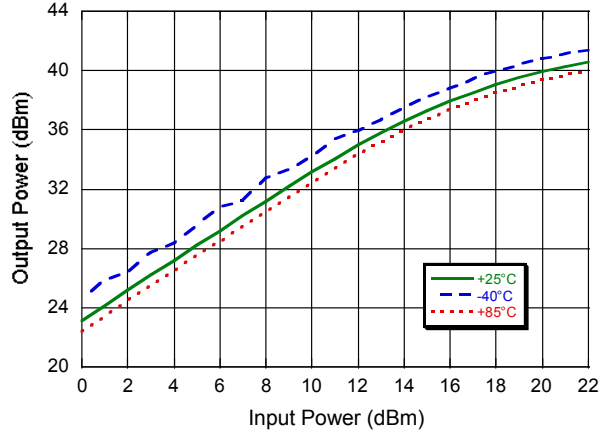


Typical Performance Curves

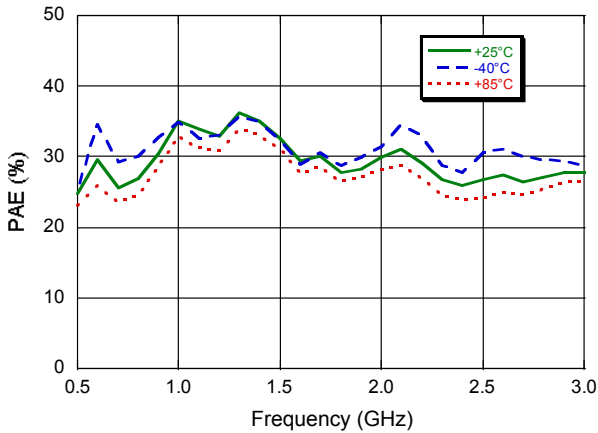
Power Gain



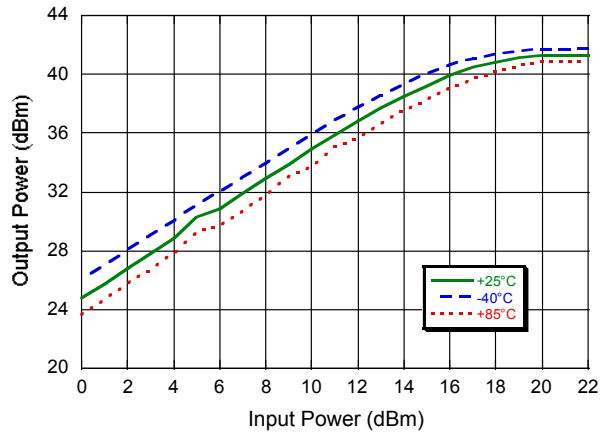
Output Power Sweep @ 0.7 GHz



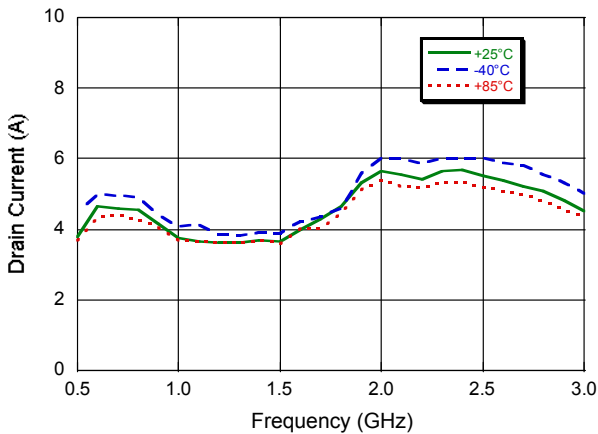
Power Added Efficiency



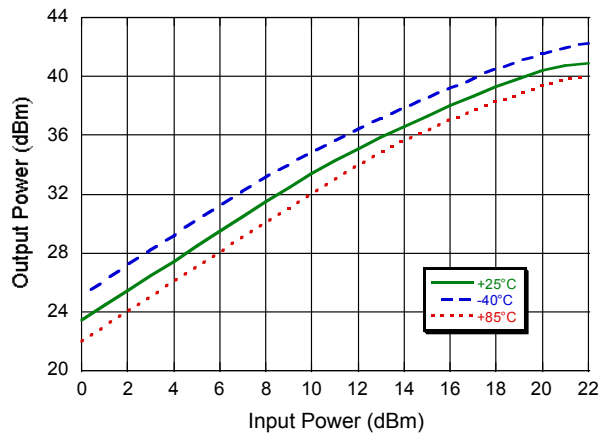
Output Power Sweep @ 1.5 GHz



Drain Current

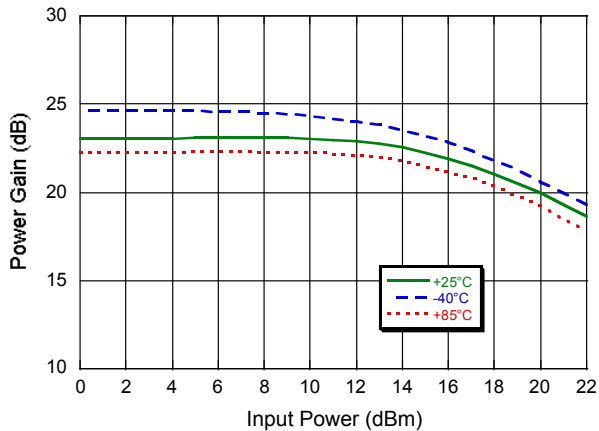


Output Power Sweep @ 2.5 GHz

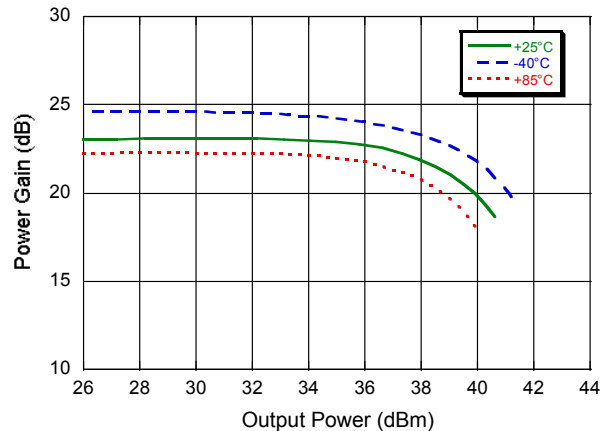


Typical Performance Curves

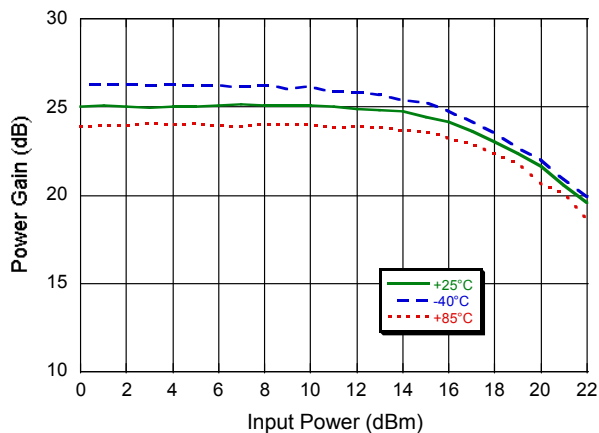
Power Gain vs. Input Power @ 0.7 GHz



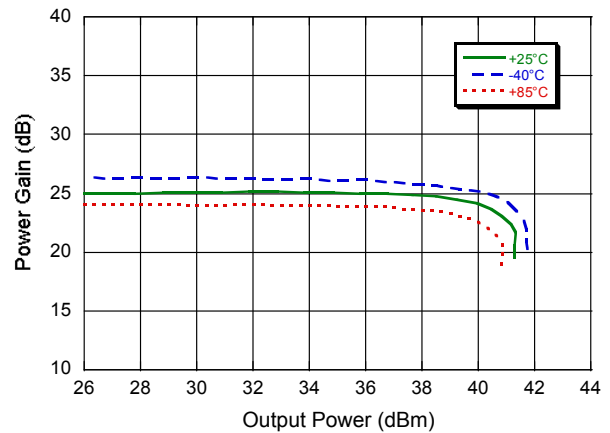
Power Gain vs. Output Power @ 0.7 GHz



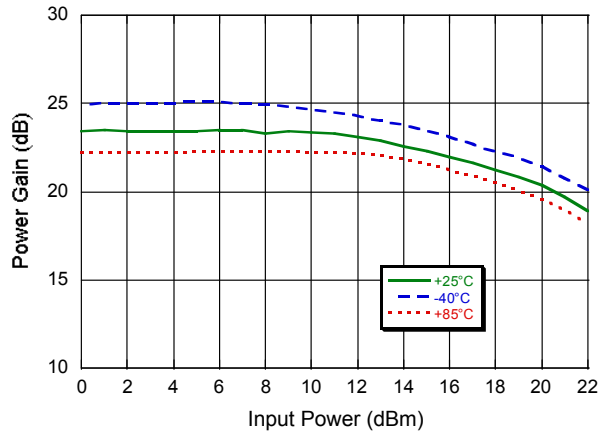
Power Gain vs. Input Power @ 1.5 GHz



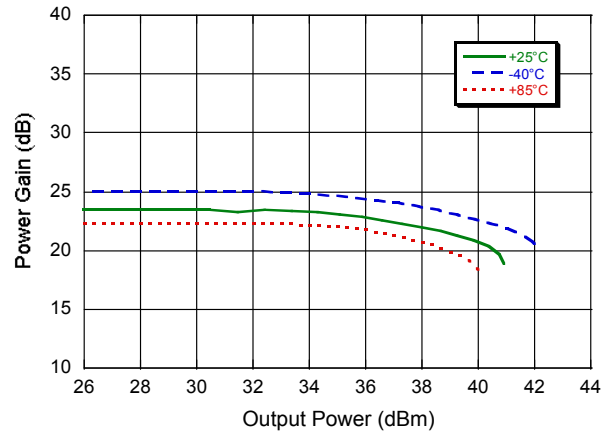
Power Gain vs. Output Power @ 1.5 GHz



Power Gain vs. Input Power @ 2.5 GHz

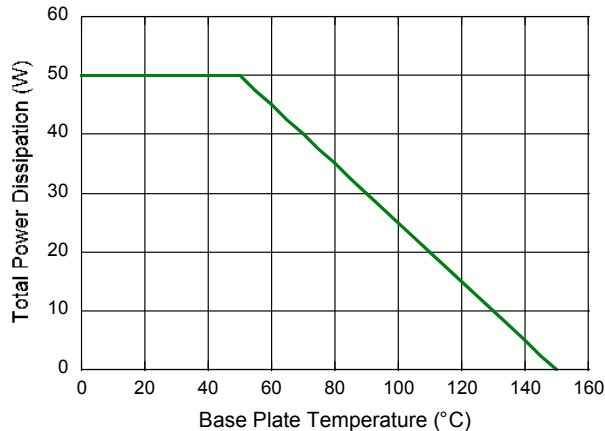


Power Gain vs. Output Power @ 2.5 GHz

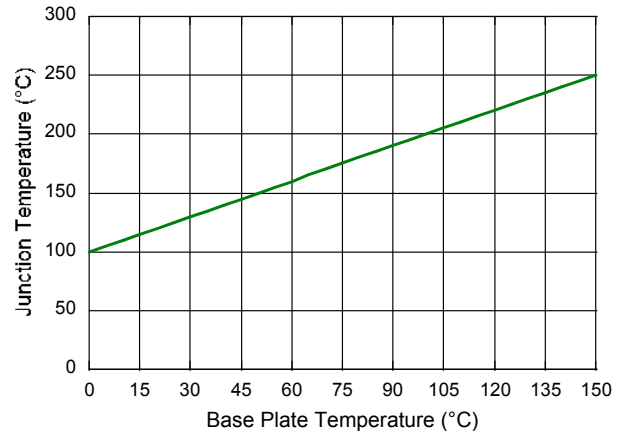


Typical Performance Curves

Max. Power Dissipation vs. Base Plate Temperature⁷

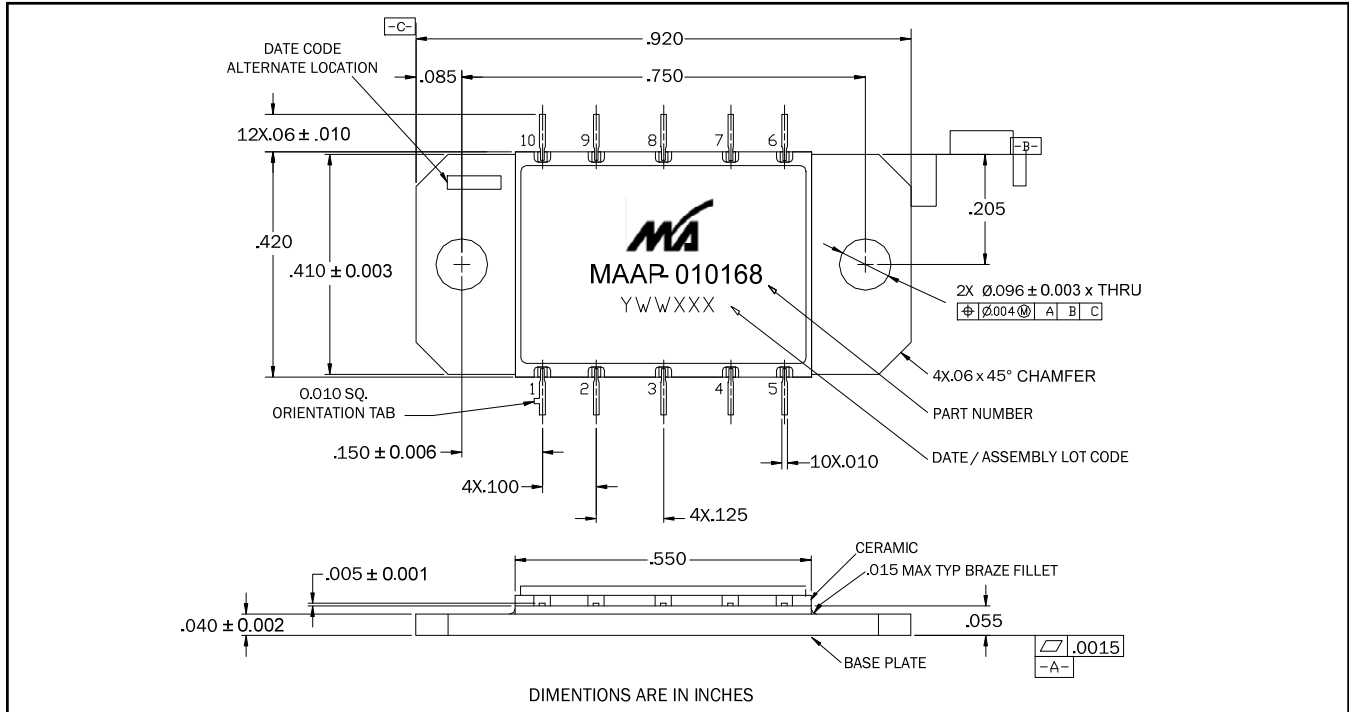


Junction Temperature vs. Base Plate Temperature with 50 W Power Dissipation



7. Power dissipation should not exceed the maximum plot shown above to maintain $T_J < 150^\circ\text{C}$. It is recommended to monitor power dissipation and decrease power dissipation in the device as required.

Ceramic Flange Mount Package[†]



[†] Reference Application Note M538 for lead-free solder reflow recommendations.

This is a high frequency, low thermal resistance package. The package consists of a cofired ceramic construction with a copper-tungsten base and iron-nickel-cobalt leads. The finish consists of electrolytic gold over nickel plate.

Данный компонент на территории Российской Федерации

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Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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